



NEWS RELEASE

For Immediate Release

QUATECH'S EXPANDED LINE OF EMBEDDED 802.11 RADIOS NOW SHIPPING

Quatech's first SDIO/SPI host interface radio is available to customers

HUDSON, OHIO – June 24, 2008 – [Quatech, Inc.](http://www.quatech.com), a leader in wireless machine-to-machine (M2M) networking and device connectivity solutions, is now shipping the recently released SDIO/SPI based interface line of Embedded Airborne 802.11b/g Radio Modules.

The Airborne Embedded 802.11b/g Radio Module is Quatech's first SDIO/SPI host interface product and the latest addition to Quatech's advanced line of radios for reliable and high performing machine-to-machine (M2M) communication. The low power radio module delivers high performance and is ideal for integrating the latest WiFi technology into designs for power sensitive and hand-held devices used in industrial, medical, surveillance, telematics and mobile enterprise applications.

The Airborne 802.11b/g Radio Module delivers a cost efficient solution provided by a small profile design and direct down SMT high density connection to the system board. The radio is a complete, high speed wireless solution that uses the latest 802.11 b/g Marvell Libertas (88W8686) chipset. The module is a true upgrade option; no soldered connections are required and the module can be upgraded in the field or added to a managed product configuration.

"The new Airborne 802.11b/g SDIO-SPI Radio provides OEMs with a very compact and low-power embedded wireless solution," said Steve Runkel, CEO of Quatech. "This radio is particularly well-suited for M2M applications, including industrial, telematics and medical devices that require the latest enterprise-class security protocols for operation in corporate networks."

Supporting the latest media streaming, roaming, power management and security standards, the low power radio module provides industrial-grade technology with advanced power management features. The radio module's powerful encryption feature supports the latest 802.11i security standards and implements AES, WEP, WPA and WPA2 along with a broad range of EAP supplicants. Reference drivers for WindowsXP, Vista, WinCE, Windows Mobile and Linux are included with Airborne

Embedded Radio Evaluation and Development Kits.

The Airborne 802.11b/g Radio Module will also provide connectivity to the family of the Blackfin EZ-Kit Lite Boards and provide support for radio drivers already ported to the Blackfin family of processors. "Analog devices is pleased to work with Quatech to offer easy connectivity that enables system designers to readily integrate Quatech's 802.11b/g radio module with the Blackfin family of processors through our Blackfin EZ-Kit Lite boards," Wayne Meyer, Strategic Marketing Manager, General Purpose DSP, Analog Devices said.

For sales and ordering information on the Airborne 802.11b/g Radio Module, please visit www.Quatech.com.

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About Quatech, Inc.

Quatech delivers high performance device networking and connectivity solutions to help companies improve their bottom line results. Its products enable reliable machine-to-machine (M2M) communications via secure 802.11 wireless or traditional wired networks, with industrial-grade embedded radios, modules, boards and external device servers, and bridges. For local and mobile connections, Quatech's serial adapters provide secure connectivity and port expansion via any interface option.

Satisfied customers worldwide rely on Quatech's unique combination of performance and support to improve operations through real-time remote monitoring and control, streamlined systems, and lowest total cost of ownership (TCO). Quatech markets its products through a global network of distributors, resellers, systems integrators and original equipment manufacturers in the transportation, instrumentation and industrial control, homeland security, medical equipment, and logistics markets. Founded in 1983, Quatech is headquartered in Hudson, Ohio. Quatech merged with DPAC Technologies (OTCBB: [DPAC](http://www.dpac.com)) in February 2006. Information concerning DPAC is filed by DPAC with the SEC and is available on the SEC website, www.sec.gov. To learn more about Quatech's complete line of device networking and connectivity solutions, visit www.quatech.com.

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Forward-Looking Statements

This press release includes forward-looking statements. You can identify these statements by their forward-looking words such as "may," "will," "expect," "anticipate," "believe," "guidance," "estimate," "intend," "predict," and "continue" or similar words or any connection with any discussion of future events or circumstances or of management's current estimates or beliefs. Forward-looking statements are subject to risks and uncertainties, and therefore results may differ materially from those set forth in those statements. More information about the risks and challenges faced by DPAC Technologies Corp. is contained in the Securities and Exchange Commission filings made by the Company on Form S-4, 10-K, 10-Q or 10-QSB and 8-K. DPAC Technologies Corp. specifically disclaims any obligation to update or revise any forward-looking statements whether as a result of new information, future developments or otherwise.